

PATENT ASSIGNMENT COVER SHEET

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
JUNJI OOSAKA	12/09/2020
YUICHI TAKENAGA	12/09/2020
AKIHIRO MATSUNAGA	12/09/2020
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City:	TOKYO
State/Country:	JAPAN
Postal Code:	150-0043
PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	17184848
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Address Line 4:	CLEVELAND, OHIO 44115
ATTORNEY DOCKET NUMBER:	HIBI10PUS01
NAME OF SUBMITTER:	PAUL R. STEFFES
SIGNATURE:	/Paul R. Steffes/
DATE SIGNED:	02/25/2021
Total Attachments: 6	
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Renner Otto Docket No.	HIBI10PUS01
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PATENT (OUS)

ASSIGNMENT OF APPLICATION FOR PATENT (US RIGHTS ONLY)

Whereas,

Name of Inventor(s)	Address
Junji OOSAKA	c/o Japan Aviation Electronics Industry, Ltd. 21-1, Dogenzaka 1-chome, Shibuya-ku, Tokyo, Japan

(hereinafter referred to as ASSIGNOR), have invented a certain invention entitled:

TITLE:	BOARD-TO-BOARD CONNECTOR
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for which application for Letters Patent of the United States has been filed under:

Application No. (<i>Express Mail Label No.</i>)	17/184,848
Filing Date (<i>Deposit Date</i>)	February 25, 2021

[Authorization is hereby given for any attorney of record in the subject patent application to insert above the application number and filing date information for this application when that information becomes available]

or, if no application is identified above, the application executed concurrently herewith.

For good and valuable consideration, receipt of which is hereby acknowledged, I have sold and assigned and hereby sell and assign to:

Assignee(s)	Address
Japan Aviation Electronics Industry, Ltd.	21-1, Dogenzaka 1-chome, Shibuya-ku, Tokyo, Japan

[If more than one assignee is listed, each owns an undivided equal share in the application and underlying invention so far as concerns the United States unless otherwise indicated or agreed to by the assignees.]

and the successors and assigns thereof, the entire right, title and interest to said invention so far as concerns the United States and the Territories and Possessions thereof, including the right to claim priority, and said application and all Letters Patent of the United States to be obtained on said application, and any related applications including any nonprovisional application, continuation, division, renewal, substitute or reissue thereof, for the full term or terms for which the same may be granted, and any U.S. nonprovisional, U.S. provisional and/or U.S. national phase patent application on which priority is claimed.

I hereby covenant that no assignment, sale, agreement or encumbrance has been or will be made or entered into that would conflict with this assignment and sale.

I further covenant that Assignee(s) will, upon request, be provided promptly with all pertinent facts and documents relating to said application, said invention and said Letters Patent as may be known and accessible to me and will testify as to the same in any proceeding related thereto and will promptly execute and deliver to Assignee(s), or the legal representative thereof, any and all papers, instruments or affidavits required to apply for, obtain, maintain and enforce said application, said invention and said Letters Patent which may be necessary or desirable to carry out the purposes hereof.

I agree that this assignment shall be construed in accordance with the law of the appropriate jurisdiction within the United States, and without regard to its conflicts of laws provisions.

Name of Inventor(s)	Date	Signature
Junji OOSAKA	December 9, 2020	Junji OOSAKA

Renner Otto Docket No.	HIBI10PUS01
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PATENT (OUS)

ASSIGNMENT OF APPLICATION FOR PATENT
(US RIGHTS ONLY)

Whereas,

Name of Inventor(s)	Address
Yuichi TAKENAGA	c/o Japan Aviation Electronics Industry, Ltd. 21-1, Dogenzaka 1-chome, Shibuya-ku, Tokyo, Japan

(hereinafter referred to as ASSIGNOR), have invented a certain invention entitled:

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Assignee(s)	Address
Japan Aviation Electronics Industry, Ltd.	21-1, Dogenzaka 1-chome, Shibuya-ku, Tokyo, Japan

[If more than one assignee is listed, each owns an undivided equal share in the application and underlying invention so far as concerns the United States unless otherwise indicated or agreed to by the assignees.]

and the successors and assigns thereof, the entire right, title and interest to said invention so far as concerns the United States and the Territories and Possessions thereof, including the right to claim priority, and said application and all Letters Patent of the United States to be obtained on said application, and any related applications including any nonprovisional application, continuation, division, renewal, substitute or reissue thereof, for the full term or terms for which the same may be granted, and any U.S. nonprovisional, U.S. provisional and/or U.S. national phase patent application on which priority is claimed.

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Name of Inventor(s)	Date	Signature
Yuichi TAKENAGA	December 9, 2020	Yuichi TAKENAGA

Renner Otto Docket No.	HIBI10PUS01
------------------------	-------------

PATENT (OUS)

ASSIGNMENT OF APPLICATION FOR PATENT (US RIGHTS ONLY)

Whereas,

Name of Inventor(s)	Address
Akihiro MATSUNAGA	c/o Japan Aviation Electronics Industry, Ltd. 21-1, Dogenzaka 1-chome, Shibuya-ku, Tokyo, Japan

(hereinafter referred to as ASSIGNOR), have invented a certain invention entitled:

TITLE:	BOARD-TO-BOARD CONNECTOR
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Name of Inventor(s)	Date	Signature
Akihiro MATSUNAGA	December 9, 2020	<i>Akihiro Matsunaga</i>